IC PACKAGES4

	Package	Material	SMD	Operating Temperature Range ⁵	Dimensions in inches ⁶ (mm)
13	PDIP-8	Plastic	N	I, T, M	0.385 x 0.300 x 0.160 (9.799 x 7.620 x 4.064)
14	CERDIP-8	Ceramic	N	I, T, M	0.380 x 0.314 x 0.2 (9.652 x 7.976 x 5.08)
15	ESOIC-14 (Narrow Body)	Plastic	Y	I, T, M	0.341 x 0.236 x 0.055 (8.65 x 6.0 x 1.397
16	QFN-24	Plastic	Y	I, T	0.197 x 0.197 x 0.038 (5.0 x 5.0 x 0.96)
17	SOIC-16 (Narrow Body)	Plastic	Y	I, T, M	0.390 x 0.236 x 0.061 (9.9 x 5.99 x 1.55)
18	QFN-16	Plastic	Y	I, T, M	0.1575 x 0.1575 x 0.039 (4.0 x 4.0 x 1.0)
HI-94249-SI 82-96-2970 82-96-2970 111111111	TSSOP-20	Plastic	Υ	I, T, M	0.2555 x 0.252 x 0.040 (6.5 x 6.4 x 1.025)
20	TSSOP-38	Plastic	Υ	I, T, M	0.382 x 0.252 x 0.04 (9.70 x 6.40 x 1.025)
21	SOIC-8	Plastic	Υ	I, T, M	0.194 x 0.236 x 0.061 (4.92 x 5.99 x 1.549)
22	QFP-64	Plastic	Υ	I, T, M	0.473 x 0.473 x 0.063 (12.0 x 12.0 x 1.6)

Notes:

- 1) "-10", "-15" or "-40" designates the use of external resistors for lightning protection of ARINC inputs. See datasheet and AN-300 & AN-301 for details of lightning protection on ARINC inputs and outputs.
- 2) Test Mode functions are part specific. See datasheet for details.
- 3) See IC Packages.
- 4) Contact your local sales representative for RoHS compliant (lead free) options.
- 5) I: -40°C to +85°C. T: -55°C to +125°C w/o burn in. M: -55°C to +125°C with burn in.
- 6) Dimensions refer to approximate footprint and height when mounted, "L x W x H". Guideline only. Data sheet dimensions should be used for design purposes.

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ARING 429 PRODUCT SELECTOR GUIDE 2012





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ARINC 429 ICs

Part Tx/Rx	Tx FIF0	Rx FIF0	Label	Host	Data	Integrated	Integrated	Test	Tri State	Supply Voltages		Dackagee ³ 4	
Number ¹	Channels	(Words)	(Words)	Filter Depth	Interface	Sheet	Line Driver	Line Receiver(s)	Mode ²	Output	Digital	Line Driver	Packages ^{3, 4}
SPI Interface I	Protocol ICs												
HI-3593	1/2	32	32	256	SPI Serial	HI-3593	1	2	Υ	N	3.3V	3.3V	1, 2
HI-3210	4/8	32K By	tes RAM	256	SPI Serial	HI-3210	-	-	Υ	N	3.3V	-	3, 22
HI-3585	1/1	32	32	256	SPI Serial	HI-3585	1	1	Υ	N	3.3V or 5V	± 5V	1, 2
HI-3587	1/0	32	-	-	SPI Serial	HI-3587	1	-	N	N	3.3V or 5V	± 5V	1, 2
HI-3588	0/1	-	32	256	SPI Serial	HI-3588	-	1	N	N	3.3V or 5V	-	1, 2
HI-3596-40	1/8	-	4	16	SPI Serial	HI-3598	-	8	Υ	N	3.3V or 5V	-	2
HI-3597-40	1/7	-	4	16	SPI Serial	HI-3598	-	7	Υ	N	3.3V or 5V	-	5
HI-3598	1/8	-	4	16	SPI Serial	HI-3598	-	8	Υ	N	3.3V or 5V	-	3, 4
HI-3599-40	0/8	-	4	16	SPI Serial	HI-3598	-	8	Υ	N	3.3V or 5V	-	2, 5
Parallel Interfa	ace Protocol I	Cs											
HI-8785	1/0	-	-	-	8-bit Parallel	HI-8783	1	-	N	N	5V	± 10V	5
HI-8788	1/0	-	-	-	16-bit Parallel	HI-8787	1	-	N	N	5V	± 10V	7
HI-8684-10	0/1	-	-	-	8-bit Parallel	HI-8683	-	1	Υ	N	5V	-	6, 8
HI-8686	0/1	-	-	-	16-bit Parallel	HI-8685	-	1	Υ	N	5V	-	7
HI-3583A-15	1/2	32	32	16	16-bit Parallel	HI-3582A	1	2	Υ	N	3.3V	± 10V	3, 4, 11
HI-3584A-15	1/2	32	32	16	16-bit Parallel	HI-3584A	-	2	Υ	N	3.3V	-	3, 4, 11
HI-8583-10	1/2	32	32	16	16-bit Parallel	HI-8582	1	2	Υ	N	5V	± 10V	4, 11
HI-8584-10	1/2	32	32	16	16-bit Parallel	HI-8584	-	2	Υ	N	5V	-	4, 11
Line Drivers													
HI-8571	1/0	-	-	-	-	HI-8570	1	-	N	N	-	± 5V	12, 13, 14
HI-8586	1/0	-	-	_	-	HI-8585	1	-	N	N	-	± 12V or ± 15V	12, 13, 14
HI-8594	1/0	-	-	_	-	HI-8592	1	-	N	Υ	_	± 5V	12, 14
HI-8592	1/0	-	-	-	-	HI-8592	1	-	N	Υ	-	+ 5V	15, 16
HI-8596	1/0	-	-	-	-	HI-8596	1	-	N	Υ	-	+ 3.3V	17, 18
Line Receivers	S												
HI-8444-10									Υ				
HI-8445-10	0/4	-	-	-	-	HI-8444	-	4	N	N	3.3V or 5V	-	19
HI-8448-10	0/8	-	-	-	-	HI-8444	-	8	Υ	N	3.3V or 5V	-	1, 2, 20
HI-8588-10	0/1	-	-	-	-	HI-8588	-	1	Υ	N	5V	-	13, 14, 21
HI-8591-40	0/1	-	-	-	-	HI-8591	-	1	Υ	N	3.3V or 5V	-	13, 14, 18, 21
													, , ,

IC PACKAGES⁴

	Package	Material	SMD	Operating Temperature Range ⁵	Dimensions in inches ⁶ (mm)
1	QFP-44	Plastic	Υ	I, T, M	0.547 x 0.547 x 0.063 (13.9 x 13.9 x 1.6)
2	QFN-44	Plastic	Υ	I, T, M	0.276 x 0.276 x 0.039 (7.0 x 7.0 x 1.0)
3	QFN-64	Plastic	Υ	I, T, M	0.354 x 0.354 x 0.039 (9.0 x 9.0 x 1.0)
4	QFP-52	Plastic	Υ	I, T, M	0.52 x 0.52 x 0.063 (13.2 x 13.2 x 1.6)
5 HI-9794PSI 86-072-3657 0746	SOIC-24 (Wide Body)	Plastic	Υ	I, T, M	0.606 x 0.407 x 0.10 (15.392 x 10.325 x 2.54)
6 HI-1573091 05-12-3651 0642 THAI	SOIC-20 (Wide Body)	Plastic	Υ	I, T, M	0.5035 x 0.4065 x 0.098 (12.789 x 10.325 x 2.489)
7 Herebara 6 Pool 7.28 Poo	QFP-32	Plastic	Υ	I, T, M	0.354 x 0.354 x 0.044 (9.0 x 9.0 x 1.2)
8 HI-BÂ92J 87-04-3918 C 7B 0745	PLCC-20	Plastic	Υ	I, T, M	0.39 x 0.39 x 0.173 (9.906 x 9.906 x 4.394)
9 PATE OF SALES	PLCC-44	Plastic	Υ	I, T, M	0.69 x 0.69 x 0.173 (17.526 x 17.526 x 4.394)
10 (1.00 p)	CerQuad-44 (J-Lead)	Ceramic	Υ	I, T, M	0.688 x 0.688 x 0.2 (17.475 x 17.475 x 5.08)
85-1937/03 85-1937/03 86-19-35/03 65-8937/03/06	CerQuad-52 (J-Lead)	Ceramic	Υ	I, T, M	0.788 x 0.788 x 0.19 (20.0 x 20.0 x 4.826)
12	ESOIC-8	Plastic	Υ	I, T, M	0.194 x 0.236 x 0.057 (4.92 x 5.99 x 1.46)